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# **HD74LS195A**

# 4-bit Parallel-Access Shift Register

REJ03D0457-0300 Rev.3.00 Jul.15.2005

This 4-bit register features parallel inputs, parallel outputs,  $J-\overline{K}$  serial inputs, shift / load control input, and a direct overriding clear. All inputs are buffered to lower the input drive requirements. The registers have two modes of operation:

- Parallel (broadside) load
- Shift (in the direction Q<sub>A</sub> toward Q<sub>D</sub>)

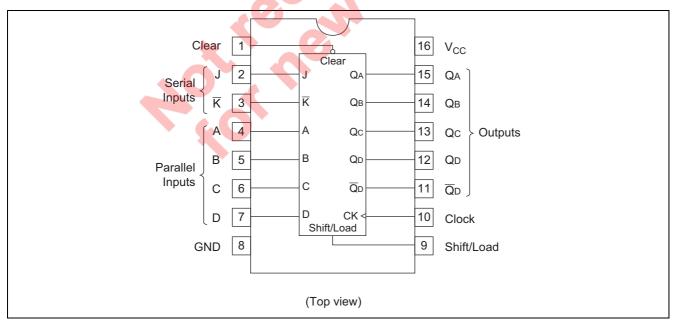
Parallel loading is accomplished by applying the four bits of data and taking the shift / load control input low. The data is loaded into the associated flip-flop and appears at the outputs after the positive transition of the clock input. During loading, serial data flow is inhibited. Shifting is accomplished synchronously when the shift / load control input is high. Serial data for this mode is entered at the  $J-\overline{K}$  inputs. These inputs permit the first stage to perform as a  $J-\overline{K}$ , D-, or T-type flip-flop as shown in the function table.

#### **Features**

• Ordering Information

Part Name	Package Type	Package Code (Previous Code)	Package Abbreviation	Taping Abbreviation (Quantity)
HD74LS195AFPEL	SOP-16 pin (JEITA)	PRSP0016DH-B (FP-16DAV)	FP	EL (2,000 pcs/reel)

# Pin Arrangement



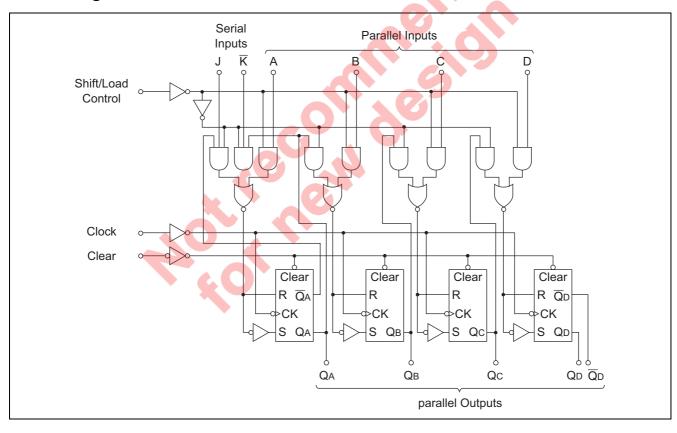
### **Function Table**

	Inputs										Outputs		
Clear	Shift /	Clock	Se	Serial		Parallel				_			_
Clear	Load	Clock	J	K	Α	В	С	D	$Q_A$	$Q_B$	Q <sub>C</sub>	$\mathbf{Q}_{D}$	$\overline{\mathbf{Q}}_{D}$
L	Х	Х	Х	Х	Х	Х	Х	Х	L	L	L	L	Н
Н	L	1	Х	Х	а	b	С	d	а	b	С	d	d
Н	Н	L	Х	Х	Х	Х	Х	Х	$Q_{A0}$	$Q_{B0}$	$Q_{C0}$	$Q_{D0}$	$\overline{Q}_{D0}$
Н	Н	1	L	Н	Х	Х	Х	Х	$Q_{A0}$	$Q_{A0}$	$Q_{Bn}$	Q <sub>Cn</sub>	$\overline{\mathbf{Q}}_{Cn}$
Н	Н	1	L	L	Х	Х	Х	Х	L	$Q_{An}$	$Q_{Bn}$	Q <sub>Cn</sub>	$\overline{\mathbf{Q}}_{Cn}$
Н	Н	1	Н	Н	Х	Х	Х	Х	Н	$Q_{An}$	$Q_{Bn}$	Q <sub>Cn</sub>	$\overline{\mathbf{Q}}_{Cn}$
Н	Н	1	Н	L	Х	Х	Х	Х	$\overline{Q}_{An}$	$Q_{An}$	$Q_{Bn}$	Q <sub>Cn</sub>	$\overline{\mathbf{Q}}_{Cn}$

Notes: 1. H; high level, L; low level, X; irrelevant

- 2. 1; transition from low to high level
- 3. a to d; the level of steady-state input at inputs A, B, C, or D, respectively
- 4.  $Q_{A0}$  to  $Q_{D0}$ ; the level of  $Q_A$ ,  $Q_B$ ,  $Q_C$ , or  $Q_D$ , respectively before the indicated steady-state input conditions were established.
- 5. Q<sub>An</sub> to Q<sub>Cn</sub>; the level of Q<sub>A</sub>, Q<sub>B</sub>, Q<sub>C</sub>, respectively before the most-recent ↑ transition of the clock.

# **Block Diagram**



### **Absolute Maximum Ratings**

Item	Symbol	Ratings	Unit
Supply voltage	V <sub>CC</sub>	7	V
Input voltage	V <sub>IN</sub>	7	V
Power dissipation	P <sub>T</sub>	400	mW
Storage temperature	Tstg	-65 to +150	°C

Note: Voltage value, unless otherwise noted, are with respect to network ground terminal.

# **Recommended Operating Conditions**

ltem		Symbol	Min	Тур	Max	Unit
Supply voltage		$V_{CC}$	4.75	5.00	5.25	V
Output current		I <sub>OH</sub>	_	_	-400	μΑ
Output current		I <sub>OL</sub>	_	_	8	mA
Operating temperat	ture	$T_{opr}$	-20	25	75	°C
Clock frequency		$f_{\sf clock}$	0	_	30	MHz
Clock pulse width		t <sub>w (CK)</sub>	16	_	_	ns
Clear pulse width		t <sub>su (CLR)</sub>	12	_	_	ns
	Shift / load		25	_	_	ns
Setup time	Serial and parallel data	t <sub>su</sub>	15	_		ns
	Clear inactive-state		25	_		ns
Release time		$t_{\text{release}}$	_	_	5	ns
Hold time		t <sub>h</sub>	0	_	_	ns

### **Electrical Characteristics**

 $(Ta = -20 \text{ to } +75 \text{ }^{\circ}\text{C})$ 

Item	Symbol	min.	typ.*	max.	Unit	Condition
Input voltage	V <sub>IH</sub>	2.0	_	_	V	
input voitage	V <sub>IL</sub>	_	_	0.8	V	
Output voltage	V <sub>ОН</sub>	2.7	-		٧	$V_{CC} = 4.75 \text{ V}, V_{IH} = 2 \text{ V}, V_{IL} = 0.8 \text{ V},$ $I_{OH} = -400 \mu\text{A}$
Output voltage	V <sub>OL</sub>			0.4	V	$I_{OL} = 4 \text{ mA}$ $V_{CC} = 4.75 \text{ V}, V_{IH} = 2 \text{ V},$
		_	1	0.5		$I_{OL} = 8 \text{ mA}$ $V_{IL} = 0.8 \text{ V}$
	I <sub>IH</sub>		1	20	μΑ	$V_{CC} = 5.25 \text{ V}, V_I = 2.7 \text{ V}$
Input current	I <sub>IL</sub>	-0	<u> </u>	-0.4	mA	$V_{CC} = 5.25 \text{ V}, V_I = 0.4 \text{ V}$
	I <sub>I</sub>	4	_	0.1	mA	V <sub>CC</sub> = 5.25 V, V <sub>I</sub> = 7 V
Short-circuit output current	los	-20	70	-100	mA	V <sub>CC</sub> = 5.25 V
Supply current**	Icc	-	14	21	mA	V <sub>CC</sub> = 5.25 V
Input clamp voltage	V <sub>IK</sub>	-	_	-1.5	V	$V_{CC} = 4.75 \text{ V}, I_{IN} = -18 \text{ mA}$

Notes:  $^*V_{CC} = 5 \text{ V}, \text{ Ta} = 25^{\circ}\text{C}$ 

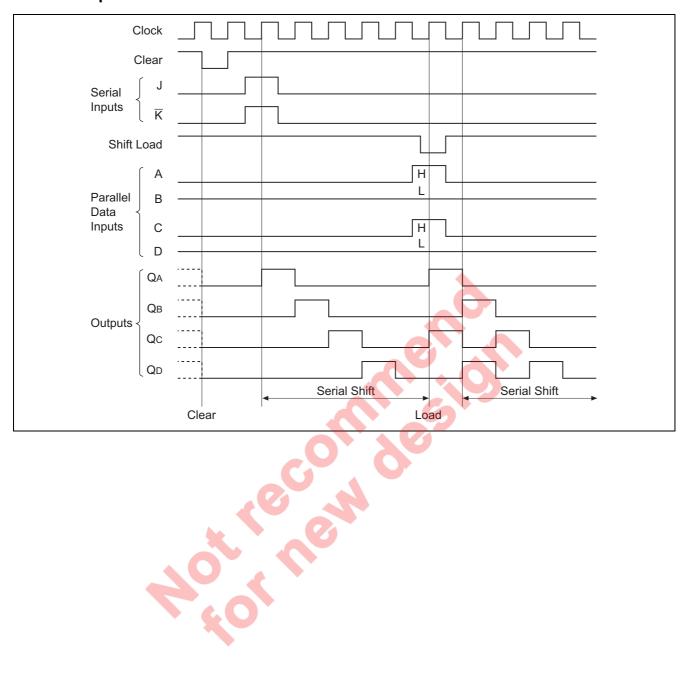
## **Switching Characteristics**

 $(V_{CC} = 5 \text{ V}, \text{Ta} = 25^{\circ}\text{C})$ 

Item	Symbol	Inputs	Outputs	min.	typ.	max.	Unit	Condition
Maximum clock frequency	$f_{\sf max}$	Clock	Q <sub>A</sub> to Q <sub>D</sub>	30	39	_	MHz	
	t <sub>PHL</sub>	Clear	Q <sub>A</sub> to Q <sub>D</sub>	_	19	30	ns	$C_L = 15 pF$ ,
Propagation delay time	t <sub>PLH</sub>	Clock	Q <sub>A</sub> to Q <sub>D</sub>	_	14	22	ns	$R_L = 2 k\Omega$
	t <sub>PHL</sub>	Clock	$\overline{Q}_D$		17	26	ns	

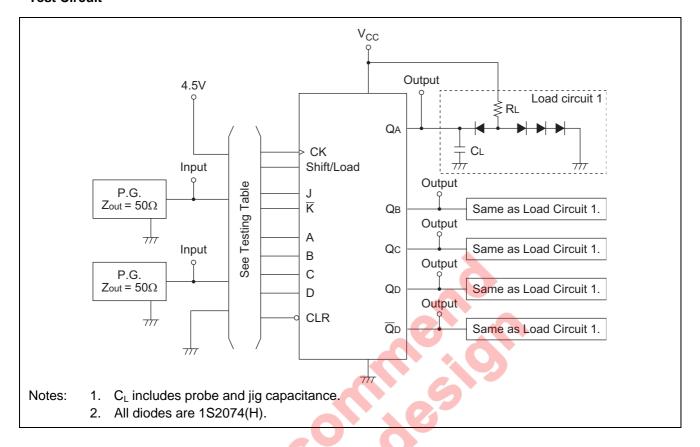
<sup>\*\*</sup> With all outputs open, shift / load grounded, and 4.5 V applied to the J, K, and data inputs, I<sub>CC</sub> is measured by applying a momentary ground, followed by 4.5 V, to clear and then applying a momentary ground, followed by 4.5 V, to clock.

# **Count Sequence**



## **Testing Method**

### **Test Circuit**

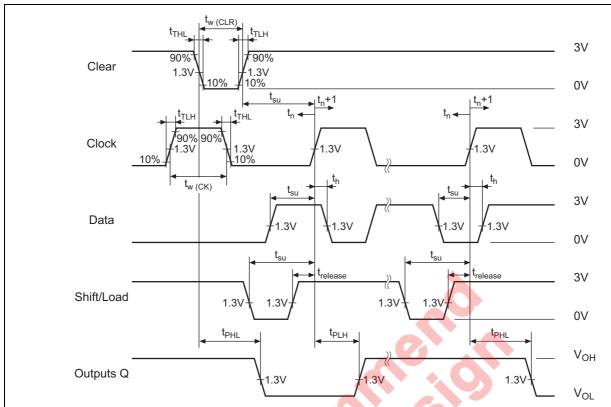


### **Testing Table**

			Inputs								
Item	From input to output	CLR	Shift / Load		ĸ	СК	Α	В	O	D	
$f_{\sf max}$		4.5V	4.5V	4.5V	GND	IN	4.5V	4.5V	4.5V	4.5V	
+	Clear $\rightarrow$ Q <sub>A</sub> to Q <sub>D</sub>	IN	GND	4.5V	4.5V	IN	4.5V	4.5V	4.5V	4.5V	
t <sub>PLH</sub>	Clock $\rightarrow$ Q <sub>A</sub> to Q <sub>D</sub> , $\overline{Q}$	4.5V	4.5V	4.5V	GND	IN	4.5V	4.5V	4.5V	4.5V	
		4.5V	GND	4.5V	4.5V	IN	IN	IN	IN	IN	

Item	From input to output	Outputs							
item		$Q_A$	Q <sub>B</sub>	Q <sub>C</sub>	$Q_D$	$\overline{\mathbf{Q}}_{D}$			
$f_{\sf max}$		OUT	OUT	OUT	OUT	OUT			
4	$Clear {\rightarrow} \ Q_A \ to \ Q_D$	OUT	OUT	OUT	OUT	_			
t <sub>PLH</sub>	Clock $\rightarrow$ Q <sub>A</sub> to Q <sub>D</sub> , $\overline{Q}_D$	OUT	OUT	OUT	OUT	OUT			
		OUT	OUT	OUT	OUT	OUT			

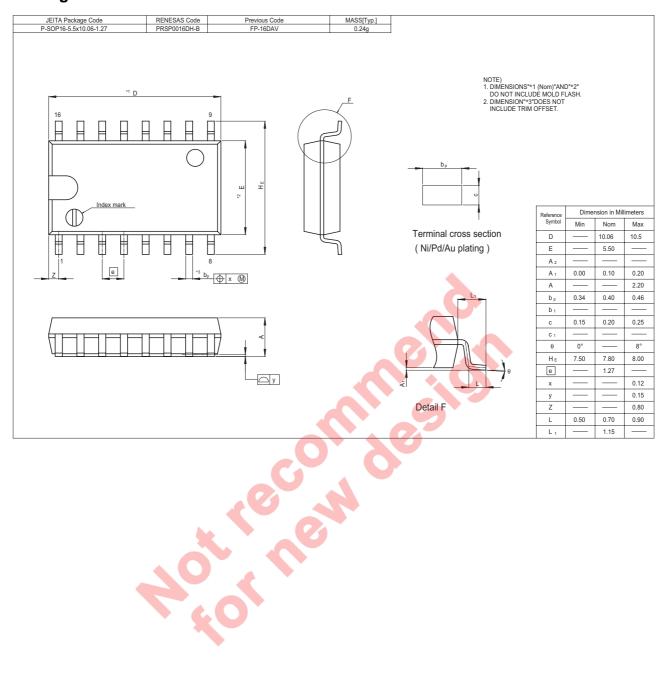
#### Waveform



Notes:

- 1. Input pulse;  $t_{TLH} \le 15$  ns,  $t_{THL} \le 6$  ns, PRR = 1 MHz, duty cycle 50%
- 2. A clear pulse is applied prior to each test.
- 3. Propagation delay times ( $t_{PLH}$  and  $t_{PHL}$ ) are measured at  $t_{n+1}$ . Proper shifting of data is verified at  $t_{n+4}$  with a functional test.
- 4. J and  $\overline{K}$  inputs are tested the same as data A, B, C, and D inputs except that shift / load input remains high.
- 5. t<sub>n</sub>; bit time beroer clocking transition.
- 6.  $t_{n+1}$ ; bit time after one clocking transition.
- 7.  $t_{n+4}$ ; bit time after four clocking transition.

## **Package Dimensions**



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